

Uni-Weld™ 1054

UV/Visible Light/LED Curable High-Strength Low Shrink Plastics Bonder

PRODUCT DESCRIPTION

Incure Uni-Weld[™] 1054 UV/Visible Light/LED curable adhesive is a high-strength industrial grade bonder for many plastics and thermoplastic elastomers. Matched with an appropriate UV lamp, it cures completely in seconds, providing extra-ordinary bonding strength of up to 10,000 PSI between PC. Used in many industrial applications, Incure 1054 is ideal for bonding of many plastics/glass devices requiring very high peel and bond strength on difficult-to-bond surfaces. Tack-free surface can be achieved with prolonged cure times. Product is 100% solids and contains no volatiles.

UNCURED PROPERTIES

Chemical Type	Urethane Acrylate, 100% Solids, No Solvents						
Appearance	Single Component, Slight Yellowish Tint						
Density, g/ml	1.10 Refractive Index			1.50	@20°C		
Flash Point, °C	> 93	>93 Toxicity Low (Refe			fer to MSDS)		
Viscosity, cP (rpm)	1,400 - 2,	,400 @20rj	om	Spindle	3		
Other viscosities are available upon request. If the viscosity range requested is not our standard offering, this product may be produced with a small lab fee. Email us at: support@uv-incure.com or your nearest local distributor for more information.					D2556		

¹ Viscosity (cP) taken at 25°C - Call to enquiry for other viscosities.

RECOMMENDED UV CURE SCHEDULE (FULL CURE)

Full Cure Ex	UVA	UVB	UVC	UVV		
Fixture Time between glass slides		mW/cm ²	150	43	5	140
Exposure Time (s)	2.0	mJ/cm ²	300	86	10	280
F200P™ @3.75" Dist	5.0	mW/cm ²	150	43	5	140
Belt Speed (ft/min)	2.8	mJ/cm ²	750	215	25	700
F500™ @3.0" Dist	10.0	mW/cm ²	500	160	15	480
Belt Speed (ft/min)	1.8	mJ/cm ²	5,000	1,600	150	4,800
S20™ Spot (4-Pole LG	i) 0.4" Dist	mW/cm ²	3,000	530	50	3,400
Exposure Time (s)	2.0	mJ/cm ²	6,000	1,060	100	6,800
L9000™ LED Spot @ 0.67" Dist		mW/cm ²	2,800	42	12	102
Exposure Time (s)	3.0	mJ/cm ²	8,400	126	36	306

Cure times on 8mm ø adhesive sample. Belt speeds using C9000-F200Px1AB (Flood) and C9000-F500x1AC (Focused Beam) conveyors for area curing. Please consult IncureLab™ for any other requirements

UV INTENSITY REFERENCE TABLE

Incure UV Curing Lamp Model	⁴ Curing Distance vs UV Intensity					
Spot Curing (Diameter)	0.5" (12.6)	1" (25.4)	1.5" (38)	2" (50.8)	2.5" (63.5)	3" (76.2)
S20™ ARC (mW/cm²) / (ø mm)	1,400 (3)	1,500 (4)	650 (6)	360 (8)	240 (10)	175 (12)
L9000™ LED (mW/cm²) / (ø mm)	7,500 (9)	5,000 (10)	2,300 (17)	1,200 (20)	700 (25)	450 (30)
Flood/Focus Beam (Area)	UV Intensity (mW/cm ²)					
F200™ ARC Flood (6" x 8")	325	280	245	215	190	165
F400™ ARC Flood (4" x 4")	860	570	440	345	270	215
F500™ ARC Focused (3" x 5")	1,040	685	530	415	325	260
L1044-365™ LED Flood (4" x 4")	2,675	2,380	1,900	1,625	1,430	1,280
L1044-405™ LED Flood (4" x 4")	2,950	2,625	2,150	1,900	1,650	1,450
⁴ Curing Distance is defined by the tip of light-guide or base of lamp housing to the bond area. All values are nominal with ±10%						

variation, with LED Flood Static Uniformity at ±78% and Dynamic Uniformity at ±90%. Recommended curing parameters in grey

UV CURING SCHEDULE FOR THIS PRODUCT

Wavength λ	UVA (320 - 400nm)	UVB (290–320nm)	UVC (290-220nm)	VUV (400-700nm)	Note: This product has been thoroughly tested to cure with F200P™ UV Flood Lamp.
Minimum Intensity	150 mW/cm ²	43 mW/cm ²	5 mW/cm ²	140 mW/cm ²	Intensity wavelengths (shaded) are crucial for curing this product. All measurements are made with EIT UV PowerPuck II. If you are unable to fully cure this product for
Total Energy Required	750 mJ/cm ²	215 mJ/cm ²	25 mJ/cm ²	700 mJ/cm ²	some reasons, pls email us for assistance with your curing information.

SHELF-LIFE, STORAGE, USE AND HANDLING OF THIS PRODUCT

Shelf-Life of this unopened product is a minimum of ONE (1) year from date of manufacture. Avoid direct exposure of bottle to visible light at all times. Containers should remained covered when not in use. Product should be stored in a dark cool place of 2°C to 20°C. Transfer of product into other packages void all warranties. Users should ensure all bonding surfaces are free of grease, mold release, or any contaminants, as bonding performance will be compromised. All tests for cured bonds should be carried out at ambient temperature. For safe handling of this product, please read Material Safety Data-sheet (MSDS) prior to use. Organic solvents, such as IPA, may be used to wipe away uncured material from surfaces.

EtO and GAMMA STERILIZATION (Not Applicable for this Product)

All Incure medical products are formulated to subject to standard sterilization methods, such as EtO and Gamma Radiation of 25 to 50 kGravs (cumulative). Enhanced moisture and thermal resistance of this product show excellent adhesion and bonding strength after one cycle of steam auto-clave test. Depending on bond design and structure of the application, users should test specific assemblies after subjecting them to sterilisation. Consult Incure Support Team for assistance, if your devices are subjected to more than one sterilization cycles.

NOTE

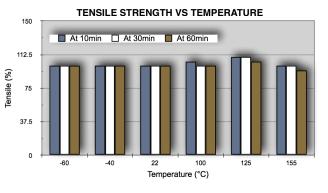
The data contained in this document are furnished for information only. We cannot assume responsibility for the results obtained by others over whose methods we have no control. It is the user's responsibility to determine suitability for the user's purpose of any production methods mentioned herein. INCURE will not be liable for any indirect, special, incidental or consequential loss or damage arising from this INCURE product, regardless of the legal theory asserted. INCURE recommends that each user adequately test its proposed use and application before repetitive use, using this data as a guide.

CURED PROPERTIES

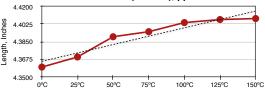
CORED PROPERTIES					
rometer	D70 to D80	ASTM 2240			
Linear Shrinkage / Expansion (-ve)		ASTM 570			
Water Absorption at 24hrs		² ISTM D2566			
PC-PC / PC-SS	10,800^ / 600	ASTM 638			
PC-S / PC-AL	1,000 / 1,300	ASTIM 038			
re	Slight-Tack	² ISTM D189			
Elongation at Break		ASTM 638			
leness / Degrades) °C	-55 to 150	2 ISTM D366			
Elasticity, MPa (PSI)	Not Available	³ ASTM 638			
), ppm/°C	a1=40 , a2=80	² ISTM D696			
	rometer xpansion (-ve) 24hrs PC-PC / PC-SS	ometer D70 to D80 xpansion (-ve) 0.03% 24hrs 0.31% PC-PC / PC-SS 10,800^ / 600 PC-S / PC-AL 1,000 / 1,300 re Slight-Tack 60% 60% leness / Degrades) °C -55 to 150 Elasticity, MPa (PSI) Not Available			

2 ISTM - refers to Incure Standard Test Method

³ ASTM 638 Young's Modulus test speed @5mm/min for rigid and semi-rigid materials, @50mm/min for non-rigid materials, unless otherwise specified.



LINEAR CTE (a1 & a2), ppm/°C



SECONDARY HEAT CURE (Not Applicable)

Continuous Oven Bake	Duration			
95°C (203°F)	120 mins			
110°C (230°F)	60 mins			
125°C (257°F)	30 mins			

Suite C-3, New Britain,	Vertex Tower B.
CT 06052, USA	Singapore 408868
Tel: (860) 748 2979	Tel: (65) 6509 3670
support@uv-incure.com	www.uv-incure.com
ROHS Pb HF	